at least one temperature measurement element formed by the second structure in the metal layer; and

a moisture barrier arranged above the metal layer and formed at least in part by a nitride layer.

- 3. (Once Amended) The mass flow sensor according to claim 1, wherein: the nitride layer is a silicon nitride layer.
- 8. (Once Amended) The mass flow sensor according to claim 1, further comprising: a further nitride layer arranged between the frame and the metal layer.
- 9. (Once Amended) The mass flow sensor according to claim 8, further comprising:
 a silicon oxide layer formed by a thermal oxidation and arranged between the further nitride layer.
- 10. (Once Amended) The mass flow sensor according to claim 9, wherein: the further nitride layer includes a silicon nitride layer.
- 11. (Once Amended) The mass flow sensor according to claim 9, further comprising:

 an oxide layer arranged in a recess area beneath the further nitride layer.
- 12. (Twice Amended) The mass flow sensor according to claim 9, further comprising: an oxide layer arranged in the membrane and below the metal layer; and a recess arranged beneath the further nitride layer; wherein the recess does not contain the oxide layer.

Please also add new claims 19-23.

- 19. (New) A mass flow sensor, comprising:
 - a frame formed at least in part by silicon;
 - a membrane held by the frame;
 - a metal layer arranged above the frame;
 - a heating element formed by a first structure in the metal layer; and